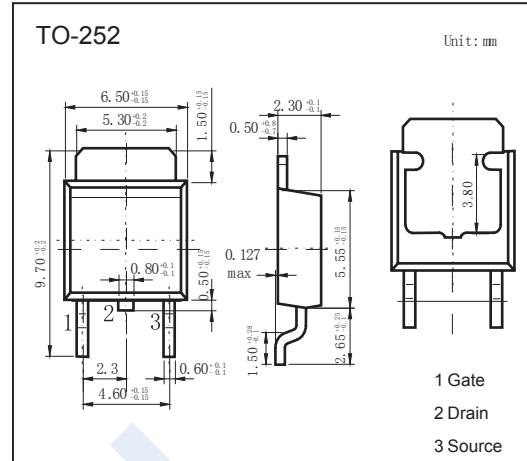
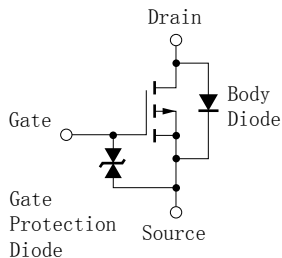


P-Channel MOSFET

2SJ598-Z

■ Features

- $V_{DS} (V) = -60V$
- $I_D = -12 A$
- $R_{DS(ON)} < 130m \Omega (V_{GS} = -10V)$
- $R_{DS(ON)} < 190m \Omega (V_{GS} = -4V)$
- Low Ciss: $C_{iss} = 720 pF (TYP.)$



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	V_{DS}	-60	V	
Gate-Source Voltage	V_{GS}	± 20		
Continuous Drain Current	I_D	-12	A	
Pulsed Drain Current (Note.1)	I_{DM}	-30		
Single Avalanche Current (Note.2)	I_{AS}	-12		
Power Dissipation	P_D	$T_c = 25^\circ C$	23	W
		$T_a = 25^\circ C$	1	
Single Avalanche Energy (Note.2)	E_{AS}	14.4	mJ	
Junction Temperature	T_J	150	$^\circ C$	
Junction Storage Temperature Range	T_{stg}	-55 to 150		

Note.1: $PW \leq 10 \mu s, Duty Cycle \leq 1\%$

Note.2: Starting $T_J = 25^\circ C, V_{DD} = -30V, R_G = 25\Omega, V_{GS} = -20V \rightarrow 0$

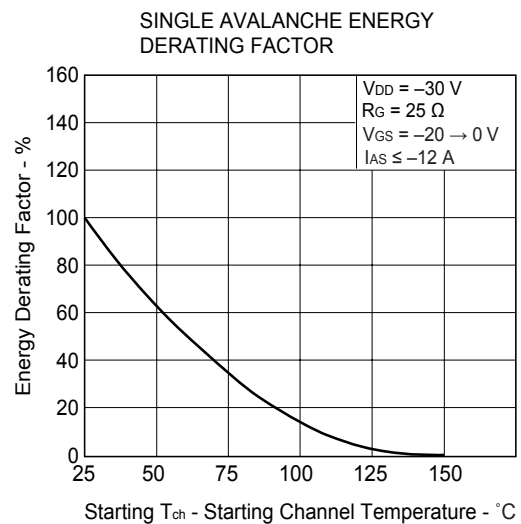
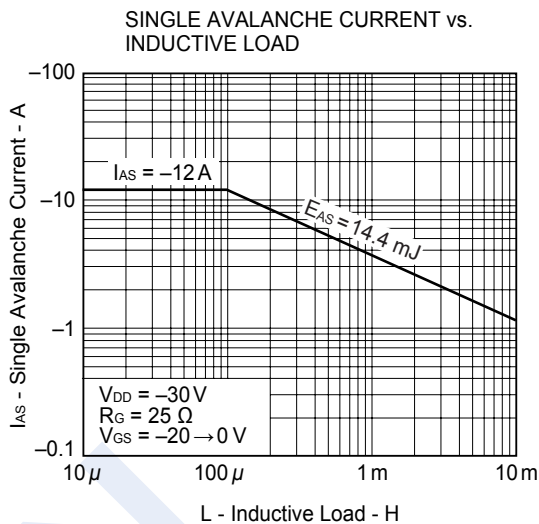
P-Channel MOSFET

2SJ598-Z

Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =-250 μA, V _{GS} =0V	-60			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V, V _{GS} =0V			-10	μA
Gate-Body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±16V			±10	μA
Gate Cut off Voltage	V _{GS(off)}	V _{DS} =-10V, I _D =-1mA	-1.5		-2.5	V
Static Drain-Source On-Resistance	R _{Ds(on)}	V _{GS} =-10V, I _D =-6A			130	mΩ
		V _{GS} =-4V, I _D =-6A			190	
Forward Transconductance	g _{FS}	V _{DS} =-10V, I _D =-6A	5	11		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =-10V, f=1MHz		720		pF
Output Capacitance	C _{oss}			150		
Reverse Transfer Capacitance	C _{rss}			50		
Total Gate Charge	Q _g	V _{GS} =-10V, V _{DS} =-48V, I _D =-12A		15		nC
Gate Source Charge	Q _{gs}			3		
Gate Drain Charge	Q _{gd}			4		
Turn-On DelayTime	t _{d(on)}	V _{GS} =-10V, V _{DS} =-30V, I _D =-6A, R _G =0 Ω		7		ns
Turn-On Rise Time	t _r			4		
Turn-Off DelayTime	t _{d(off)}			35		
Turn-Off Fall Time	t _f			10		
Body Diode Reverse Recovery Time	t _{rr}	I _F =-12A, V _{GS} =0, di/dt=100A/μs		50		ns
Body Diode Reverse Recovery Charge	Q _{rr}			100		
Diode Forward Voltage	V _{SD}	I _F =-12A, V _{GS} =0V		-0.98		V

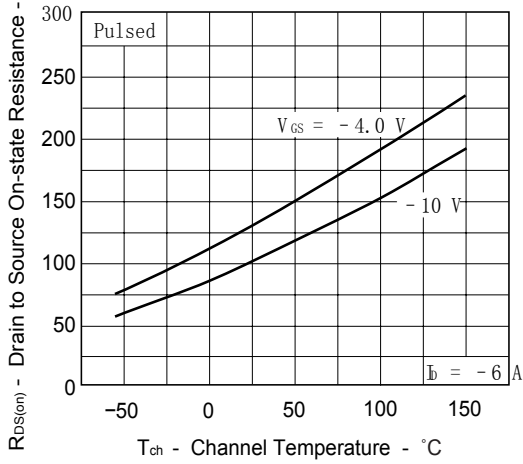
Typical Characteristics



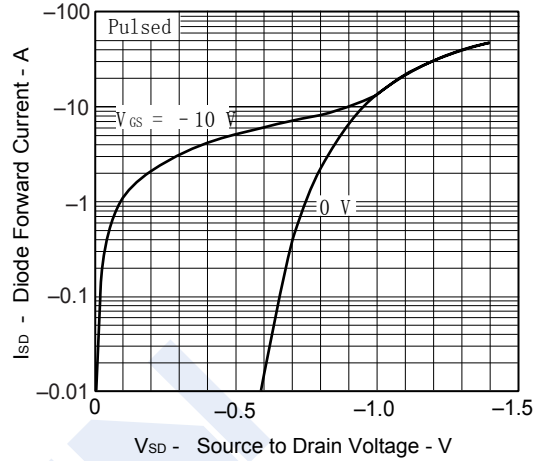
P-Channel MOSFET 2SJ598-Z

■ Typical Characteristics

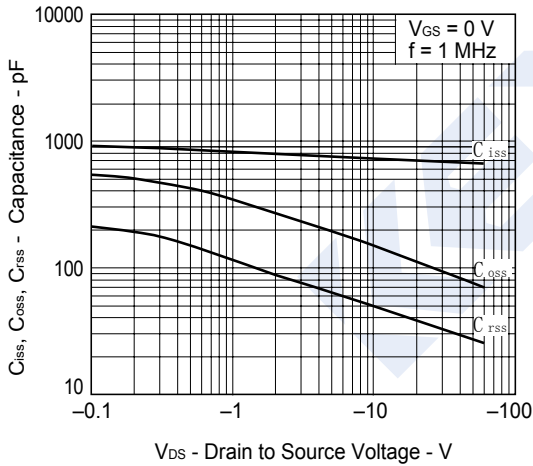
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



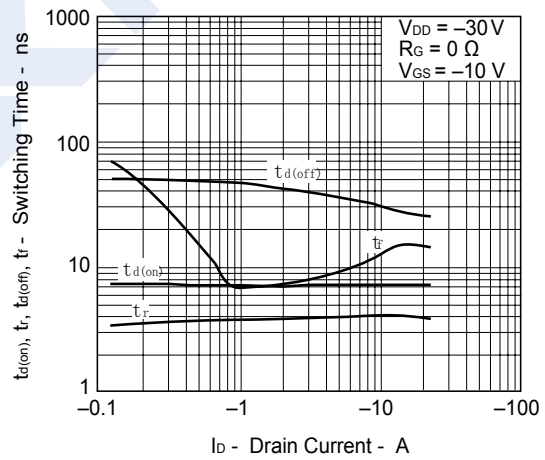
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



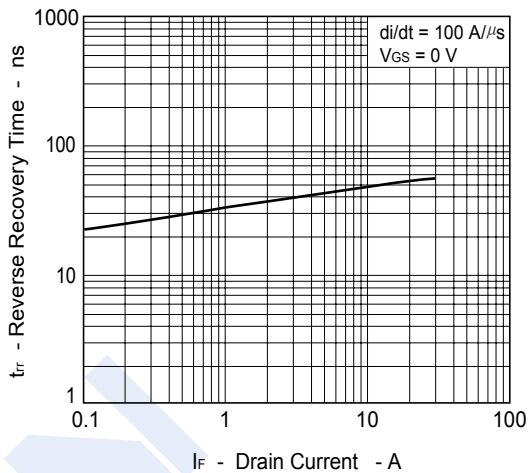
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



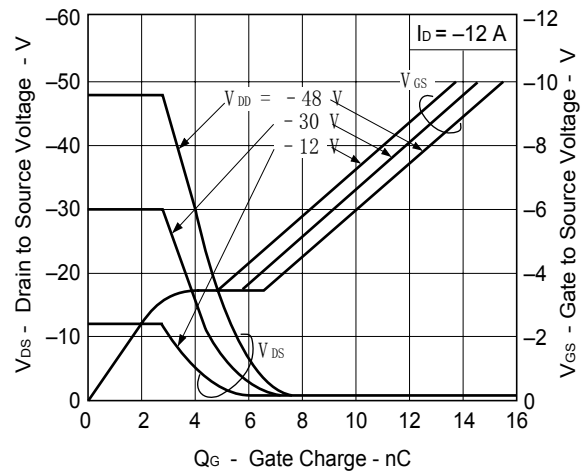
SWITCHING CHARACTERISTICS



REVERSE RECOVERY TIME vs. DRAIN CURRENT

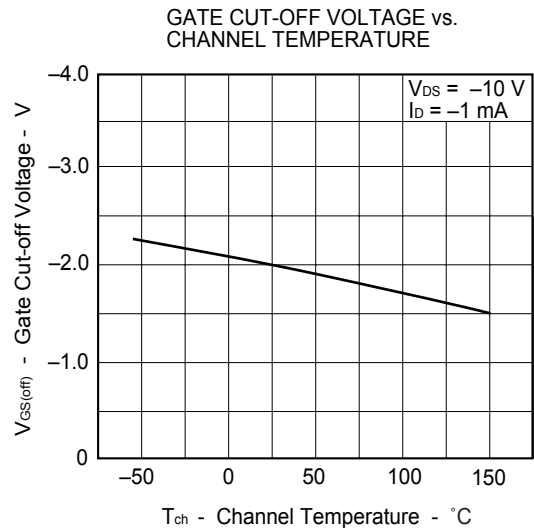
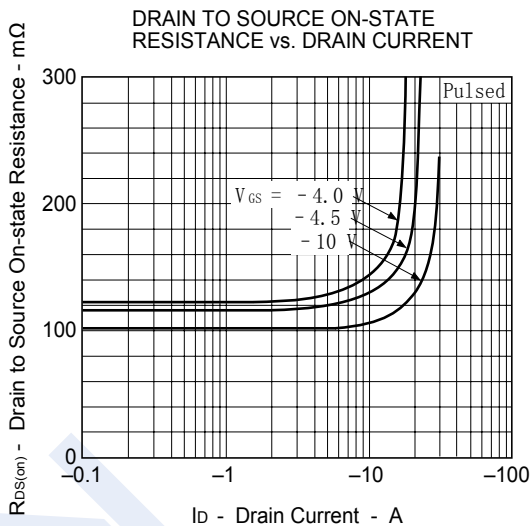
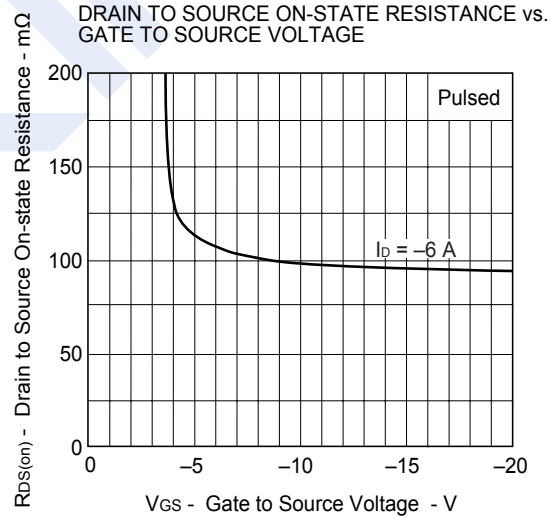
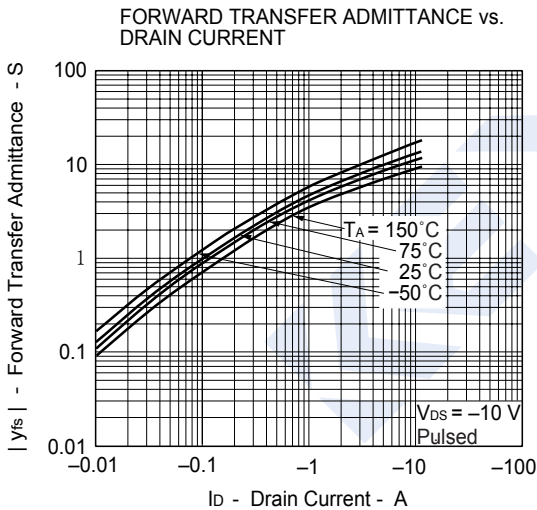
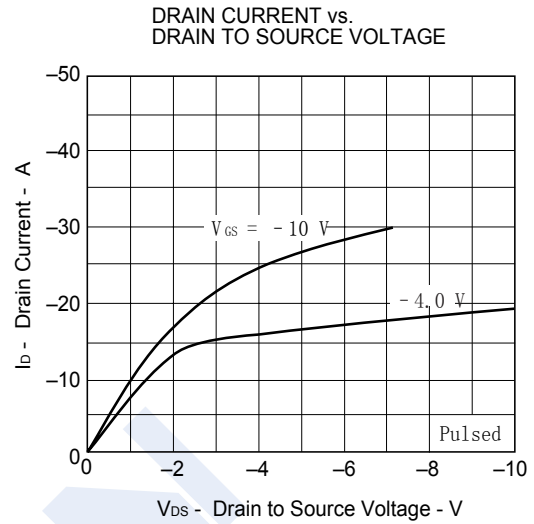
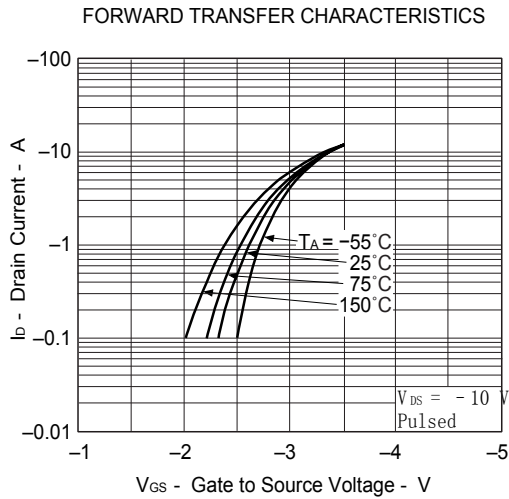


DYNAMIC INPUT/OUTPUT CHARACTERISTICS



P-Channel MOSFET 2SJ598-Z

■ Typical Characteristics



P-Channel MOSFET 2SJ598-Z

■ Typical Characteristics

